



SMD Comm X7R HV, Ceramic, 0.015 uF, 10%, 500 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 1812, 2.3 mm



General Information		
Series	SMD Comm X7R HV	
Style	SMD Chip	
Description	SMD, MLCC, High Voltage, Temperature Stable	
Features	High Voltage	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	95 mg	
Shelf Life	78 Weeks	
MSL	1	

Dimensions	
Chip Size	1812
L	4.5mm +/-0.3mm
W	3.2mm +/-0.3mm
Т	1mm +/-0.10mm
S	2.3mm MIN
В	0.6mm +/-0.35mm

4000

Packaging Quantity

L	4.5mm +/-0.3mm	Measurement Condition
W	3.2mm +/-0.3mm	Tolerance
Т	1mm +/-0.10mm	Voltage DC
S	2.3mm MIN	Dielectric Withstanding Voltage
В	0.6mm +/-0.35mm	Temperature Range
		Temp. Coefficient
Packaging Specifications		Capacitance Change with
Packaging	T&R, 330mm, Plastic Tape	Reference to +25°C and 0 VDC

Specifications	
Capacitance	0.015 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	66.6667 GOhms

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